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FDMS86202ET120

N-Channel Shielded Gate PowerTrench[®] MOSFET 120 V, 102 A, 7.2 m Ω

Features

- Extended T_J rating to 175°C
- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 7.2 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 13.5 \text{ A}$
- Max $r_{DS(on)} = 10.3 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 11.5 \text{ A}$
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

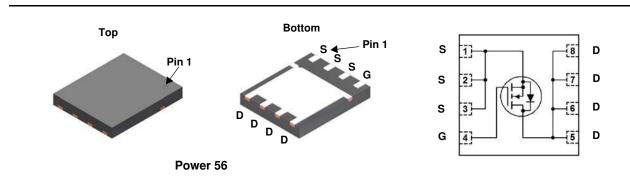


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	Ratings	Units			
V _{DS}	Drain to Source Voltage			120	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	102		
	-Continuous	T _C = 100 °C	(Note 5)	72	A	
D	-Continuous	T _A = 25 °C	(Note 1a)	13.5	A	
	-Pulsed		(Note 4)	538		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	600	mJ	
P _D	Power Dissipation	T _C = 25 °C		187	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.3	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note	a) 45	C/VV

Package Marking and Ordering Information

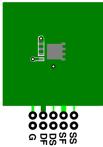
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86202ET	FDMS86202ET120	Power 56	13 "	12 mm	3000 units

January 2015

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	120			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		103		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 96 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-10		mV/°C
		V _{GS} = 10 V, I _D = 13.5 A		6.0	7.2	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 11.5 A		8.1	10.3	mΩ
		V_{GS} = 10 V, I _D = 13.5 A,T _J = 125 °C		10.9	13.2	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 13.5 A		44		S
Dvnamic	Characteristics					
	Input Capacitance			3275	4585	pF
C _{iss}		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		3275 460	4585 644	pF pF
C _{iss} C _{oss}	Input Capacitance	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz				
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance		0.1	460	644	pF
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance		0.1	460 17	644 30	pF pF
C _{iss} C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance		0.1	460 17	644 30	pF pF
C _{iss} C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics		0.1	460 17 0.9	644 30 2.7	pF pF Ω
C _{iss} C _{oss} C _{rss} R _g Switching t _{d(on)} t _r	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	f = 1 MHz	0.1	460 17 0.9 21	644 30 2.7 33	pF pF Ω ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ \hline \\ R_g \\ \hline \\ Switching \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance 5 Characteristics Turn-On Delay Time Rise Time	f = 1 MHz	0.1	460 17 0.9 21 8.75	644 30 2.7 33 17.5	pF pF Ω ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ \hline \\ R_g \\ \hline \\ Switching \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$f = 1 \text{ MHz}$ $V_{DD} = 60 \text{ V}, I_D = 13.5 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$	0.1	460 17 0.9 21 8.75 27.2	644 30 2.7 33 17.5 44	pF pF Ω ns ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ Switching \\ t_{d(on)} \\ t_r \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	f = 1 MHz $V_{DD} = 60 \text{ V}, I_D = 13.5 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	0.1	460 17 0.9 21 8.75 27.2 6.1	644 30 2.7 33 17.5 44 12.2	pF pF Ω ns ns ns
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$f = 1 \text{ MHz}$ $V_{DD} = 60 \text{ V}, I_D = 13.5 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$	0.1	460 17 0.9 21 8.75 27.2 6.1 45	644 30 2.7 33 17.5 44 12.2 64	pF pF Ω ns ns ns ns nc

V _{SD}	Source to Urain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	0.69	1.2	V
		$V_{GS} = 0 V, I_S = 13.5 A$ (Note 2)	0.76	1.3	
t _{rr}	Reverse Recovery Time	I _F = 13.5 A, di/dt = 100 A/μs		79	127	ns
Q _{rr}	Reverse Recovery Charge	$F = 10.5 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}$		140	224	nC

Notes: 1. $R_{\theta,JA}$ is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,CA}$ is determined by the user's board design.



a) 45 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 115 °C/W when mounted on a minimum pad of 2 oz copper.

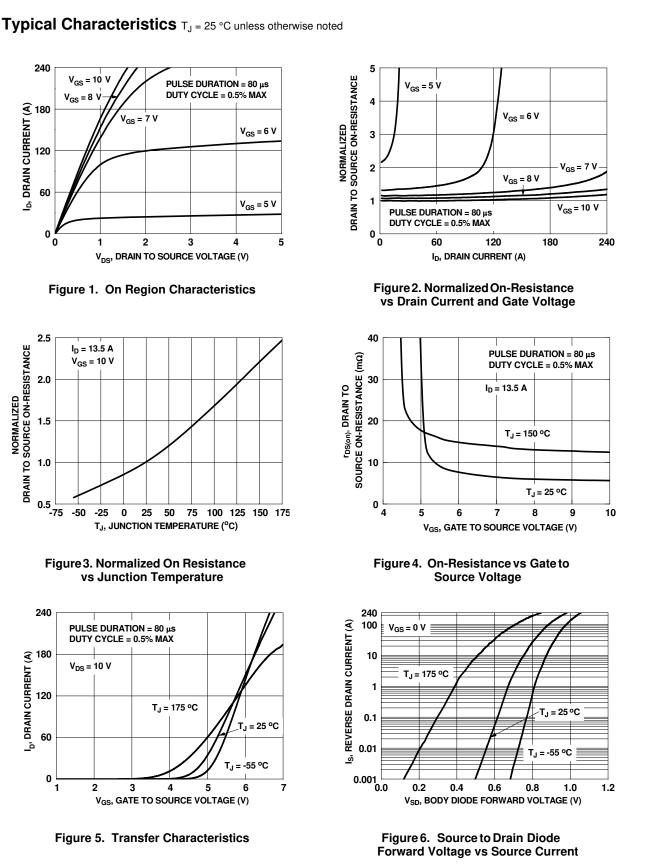
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

3. E_{AS} of 600 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 20 A, V_{DD} = 120 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 65 A.

4. Pulse Id please refer to Fig.11 SOA curve for detail.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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I_D, DRAIN CURRENT (A) 9)71 9

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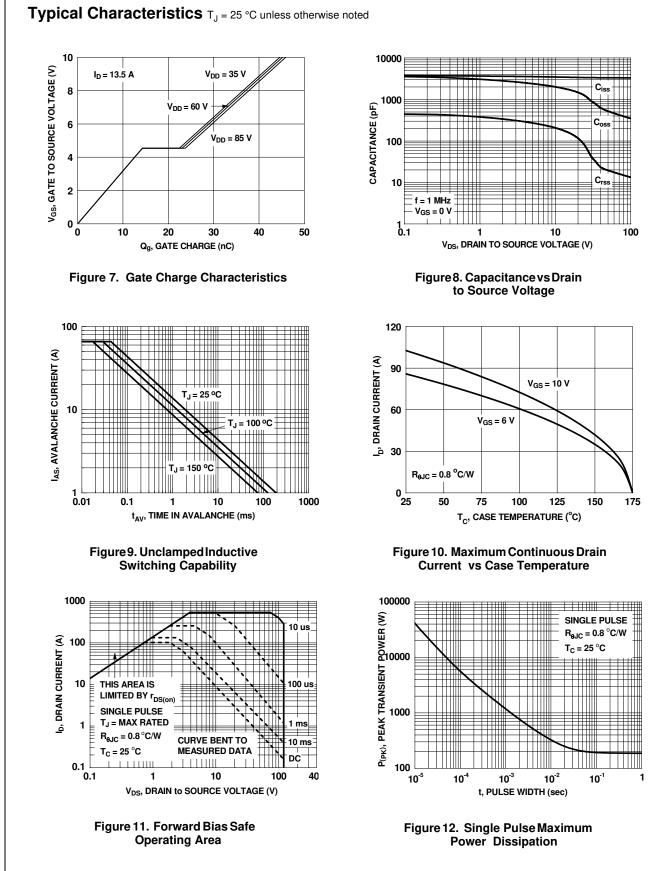
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NORMALIZED DRAIN TO SOURCE ON-RESISTANCE

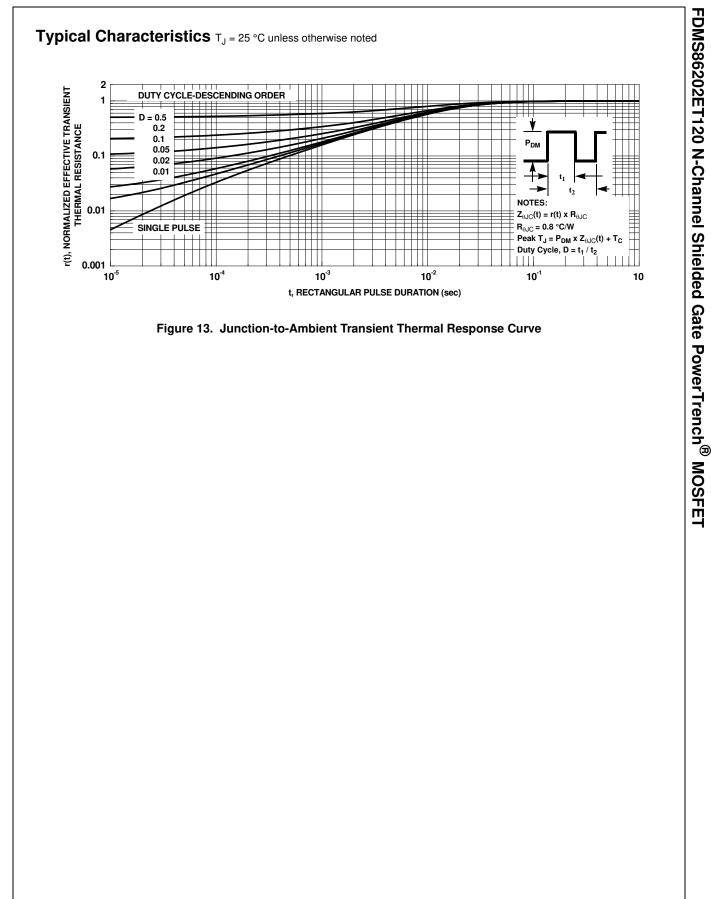
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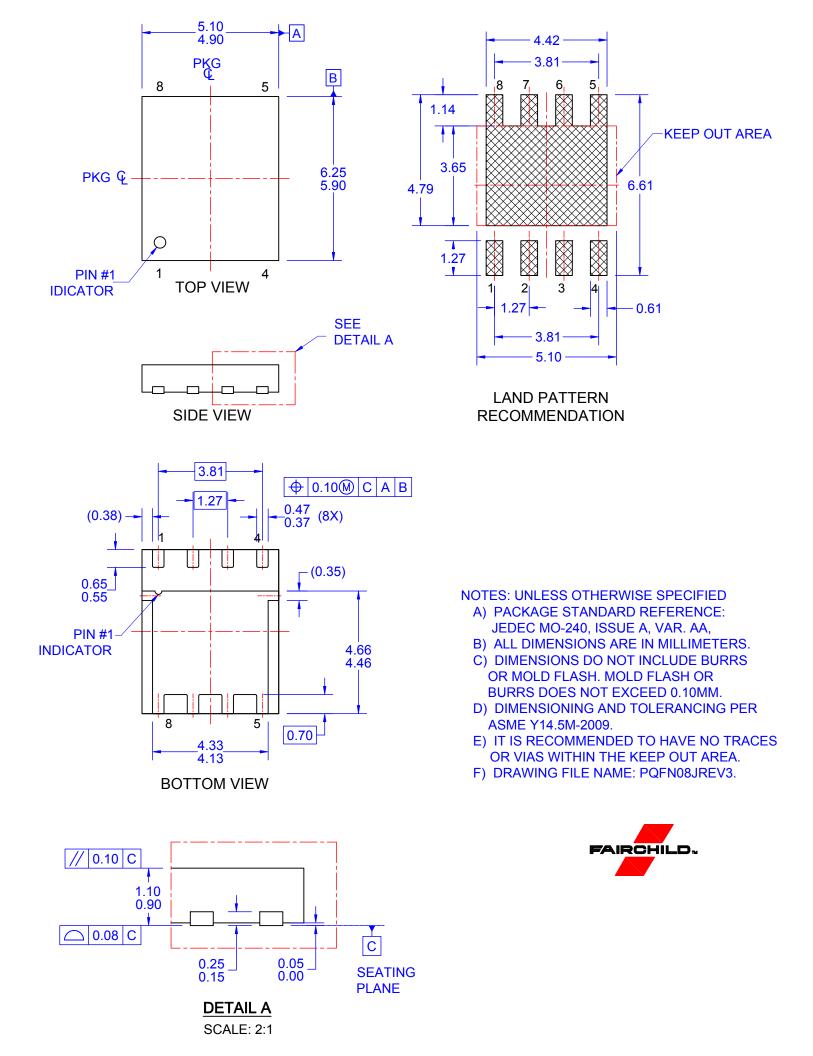
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V_{GS} = 8 V



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